Receipt date: 10/29/2004

Chart 4 of 2											
Sheet 1 of 2 Form PTO/SB/08					CYET NO		CERI	AL NO.			
PE PIO/SB/08A							AL NO. 4,445				
LIST		FERENCES COE	D C	APPLICAN Edward W	NT(S) V. MERRILL et a	al.			<u></u>		
BY APPLICANT(6) Date Submitted: October 29, 2004				SILING DATE anuary 19, 2001			GROUP 1711				
		VEN	To manes	S. PATENT	DOCUMENTS			·			
*EXAMINER INITIAL		DOCUMENT NUMBER	(M/D/Y)		NAME	CLASS		SUBCLASS		FILING DATE IF APPROPRIATE	
	F01	6,641,617	11/4/03	Merrill et a	ıl.	623		23.58			
	F02	6,786,933	9/7/04	Merrill et a	ıl.	623		23.58			
			FOR	EIGN PATEN	NT DOCUMENT	-S				-	
		DOCUMENT NUMBER	DATE (M/D/Y)	CO	DUNTRY		ASS	SUBCLASS	TRANSLATION YES NO		
	F03	WO94/27651	12/8/94	WIPO	<u> </u>						
	F04	WO93/10953	6/10/93	WIPO							
	F05	EP0847765	6/17/98	EPO							
	F06	EP1005872	6/7/00	EPO							
	F07	AU-B-64364/94	12/20/94	Australia					-		
	F08	JP62243634	10/24/87	Japan					Abstract		
	F09	JP59168050	9/21/84	Japan					Abstract		
	F10	BE1001574A6	12/5/89	Belgium						No	
		OTHER DOCI	JMENT(S) (I	ncluding Aut	thor, Title, Date,	Pertine	nt Page	s, Etc.)	·	<u>- </u>	
	F11	Bennett et al.									
<u> </u>	F12	de Boer et al.	Polymer 23: 1944-1952 (1982)								
	F13	Grulke	Polymer Process Engineering, p. 419, PTR Prentice Hall (1994)								
	F14	Howmedica	Overview and Fundamentals of UHMWPE, Part 1 of a Series on Ultra-High Molecular Weight Polyethylene, p. 1-8 (1994)								
	F15	Howmedica	Material Properties, Product Quality Control and Their Relation to UHMWPE Performance, Part 2 of a Series on Ultra High Molecular Weight Polyethylene, p. 1-20 (1994)								
	F16	Howmedica	A Comparative Analysis Analysis of the Properties of Standard and "Enchanced" Ultra- High Molecular Weight Polyethylene, Part 3 of a Series on Ultra High Molecular Weight Polyethylene, p. 1-12 (1994)								
	F17	Howmedica	Duration Stabilized UHMWPE, A Polyethylene with Superior Resistance to Oxidation, Part 4 of a Series on Ultra High Molecular Weight Polyethylene, p. 1-12 (1998)								
	F18	Kamel et al.	J. of Polymer Science: Polymer Physics Edition 23: 2407-2409 (1985)								
	F19	Lancaster	Friction and Wear, Polymer Science, Chapter 14: 960-1046 (1972)								
	F20	Li et al.		ne Journal of Bone and Joint Surgery 76-A: 1080-1090 (1994)							
	F21	Miller et al.	Wear 28: 2	207-216 (197 	·						
EXAMINER	/St	usan Berman/			DATE CONSI	DERED	0	5/17/2009			

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Receipt date: 10/29/2004

Chact 2 -f 2				=======================================						
Sheet 2 of 2	Δ			ATTY DOCUET NO	Ter	DIAL NO				
Form PTO/SB/08A				ATTY DOCKET NO. SERIAL NO. 09/764,445						
i		FERENCES CUTE	<u>.</u>	APPLICANT(S) Edward W. MERRILL	et al.					
act 2 sees				FILING DATE January 19, 2001		GROUP 1711				
		EAT	2000	S. PATENT DOCUMENTS	S					
*EXAMINER INITIAL		DOCUMENT NUMBER	(M/D/Y)	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE			
				IGN PATENT DOCUMEN						
		DOCUMENT NUMBER	DATE (M/D/Y)	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO			
		OTHER DOC	JMENT(S) (II	ncluding Author, Title, Da	te, Pertinent Pa	ages, Etc.)		•		
	F22	Narkis et al.		Macromol. Sci Phys. B26(1): 37-58 (1987)						
	F23	Qu et al.	J. of Applie	ed Polymer Science 48: 711-719 (1993)						
	F24	Ratner et al.	Abrasion o	on of Rubber 145-154 (1967)						
· · · · ·	F25	Rose et al.	Biomaterials 11: 63-67 (1990)							
	F26	Rosen	Fundamental Principles of Polymeric Materials, p.40, John Wiley & Sons, Inc. (1993)							
	F27	Shen et al.		Wear 30: 349-364 (1974)						
	F28	Shinde et al.	J. of Polymer Science: Polymer Physics Edition 23: 1681-1689 (1985)							
								·		
	-						···			
								· - -		
EXAMINER		unan Parman/		DATE CON	SIDERED	 0E/47/0000				
	/5	usan Berman/				05/17/2009				

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.